

# NUP1301 Ultra low capacitance ESD protection array Rev. 01 – 11 May 2009

**Product data sheet** 

### 1. Product profile

#### 1.1 General description

Ultra low capacitance ElectroStatic Discharge (ESD) protection array in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package designed to protect one signal line in rail-to-rail configuration from the damage caused by ESD and other transients.

#### 1.2 Features

- ESD protection of one signal line (rail-to-rail configuration)
- Ultra low diode capacitance: C<sub>d</sub> = 0.6 pF
- Very low reverse leakage current: ≤ 30 nA
- ESD protection up to 30 kV
- IEC 61000-4-2; level 4 (ESD)
- IEC 61000-4-5 (surge); I<sub>PP</sub> = 11 A at t<sub>p</sub> = 8/20 μs
- AEC-Q101 qualified

#### **1.3 Applications**

- Telecommunication networks
- Video line protection
- Microcontroller protection
- I<sup>2</sup>C-bus protection
- Antenna power supply
- Analog audio
- Class-D amplifier

#### **1.4 Quick reference data**

#### Table 1. Quick reference data

 $T_{amb} = 25 \circ C$  unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per diode						
V <sub>RRM</sub>	repetitive peak reverse voltage		-	-	80	V
C <sub>d</sub>	diode capacitance	f = 1 MHz; V <sub>R</sub> = 0 V	-	0.6	0.75	pF
I <sub>R</sub>	reverse current	V <sub>R</sub> = 80 V	-	-	100	nA

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# 2. Pinning information

Symbol GND	Description ground	Simplified outline	Graphic symbol
-	ground		
V <sub>CC</sub>	supply voltage		3
I/O	input/output		
			I/O input/output

# 3. Ordering information

Table 3.         Ordering information					
Type number Package					
	Name	Description	Version		
NUP1301	-	plastic surface-mounted package; 3 leads	SOT23		

### 4. Marking

Type number	Marking code <sup>[1]</sup>
NUP1301	LJ*

- \* = p: made in Hong Kong
- \* = t: made in Malaysia
- \* = W: made in China

### 5. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Per diode					
V <sub>RRM</sub>	repetitive peak reverse voltage		-	80	V
V <sub>R</sub>	reverse voltage		-	80	V
I <sub>F</sub>	forward current		<u>[1]</u> _	215	mA
I <sub>FRM</sub>	repetitive peak forward current	$t_p \leq 1 \text{ ms; } \delta \leq 0.25$	-	500	mA

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Symbol	Parameter	Conditions	Min	Мах	Unit
I <sub>FSM</sub>	non-repetitive peak	square wave	[2]		
forward current	forward current	t <sub>p</sub> = 1 μs	-	4	А
		t <sub>p</sub> = 1 ms	-	1	А
		t <sub>p</sub> = 1 s	-	0.5	А
Per device	e				
P <sub>PP</sub>	peak pulse power	t <sub>p</sub> = 8/20 μs	<u>[3][4]</u>	220	W
I <sub>PP</sub>	peak pulse current	t <sub>p</sub> = 8/20 μs	<u>[3][4]</u>	11	А
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[5][6]</u>	250	mW
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-55	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

#### Table 5. Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134).

[1] Pulse test:  $t_p \le 300 \ \mu s$ ;  $\delta \le 0.02$ .

[2]  $T_j = 25 \ ^{\circ}C$  prior to surge.

- [3] Non-repetitive current pulse 8/20 µs exponential decay waveform according to IEC 61000-4-5.
- [4] Measured from pin 3 to pins 1 and 2 (pins 1 and 2 are connected).
- [5] Single diode loaded.

[6] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

#### Table 6.ESD maximum ratings

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>ESD</sub>	electrostatic discharge voltage	IEC 61000-4-2 (contact discharge)	<u>[1][2]</u>	-	30	kV
		machine model		-	400	V
		MIL-STD-883 (human body model)		-	10	kV

[1] Device stressed with ten non-repetitive ESD pulses.

[2] Measured from pin 3 to pins 1 and 2 (pins 1 and 2 are connected).

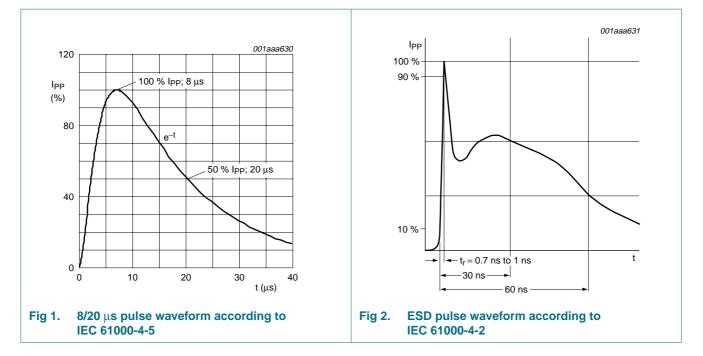
#### Table 7. ESD standards compliance

Standard	Conditions
IEC 61000-4-2; level 4 (ESD)	> 15 kV (air); > 8 kV (contact)
MIL-STD-883; class 3B (human body model)	> 8 kV

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# 6. Thermal characteristics

Table 8.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per devie	e					
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	<u>[1][2]</u> _	-	500	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		-	-	360	K/W

[1] Single diode loaded.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

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# 7. Characteristics

<b>Table 9.</b> T <sub>amb</sub> = 25	Electrical characteristics °C unless otherwise specifie					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per diode	9					
V <sub>BR</sub>	breakdown voltage	I <sub>R</sub> = 100 μA	100	-	-	V
V <sub>F</sub>	forward voltage		<u>[1]</u>			
		I <sub>F</sub> = 1 mA	-	-	715	mV
		I <sub>F</sub> = 10 mA	-	-	855	mV
		I <sub>F</sub> = 50 mA	-	-	1	V
		I <sub>F</sub> = 150 mA	-	-	1.25	V
I <sub>R</sub>	reverse current					
		V <sub>R</sub> = 25 V	-	-	30	nA
		V <sub>R</sub> = 80 V	-	-	100	nA
		V <sub>R</sub> = 25 V; T <sub>j</sub> = 150 °C	-	-	25	μA
		V <sub>R</sub> = 80 V; T <sub>j</sub> = 150 °C	-	-	35	μΑ
C <sub>d</sub>	diode capacitance	$f = 1 \text{ MHz}; V_R = 0 \text{ V}$	-	0.6	0.75	pF
Per devic	e					
V <sub>CL</sub>	clamping voltage	I <sub>PP</sub> = 1 A	[2][3]	-	3	V
		I <sub>PP</sub> = 11 A	[2][3]	-	20	V

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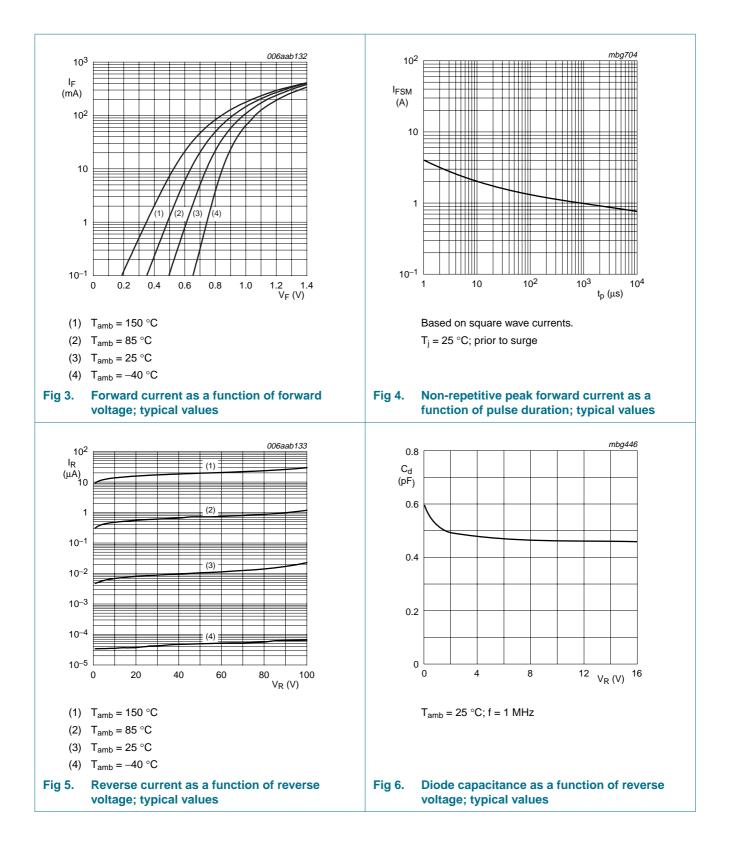
[2] Non-repetitive current pulse 8/20 µs exponential decay waveform according to IEC 61000-4-5.

[3] Measured from pin 3 to pins 1 and 2 (pins 1 and 2 are connected).

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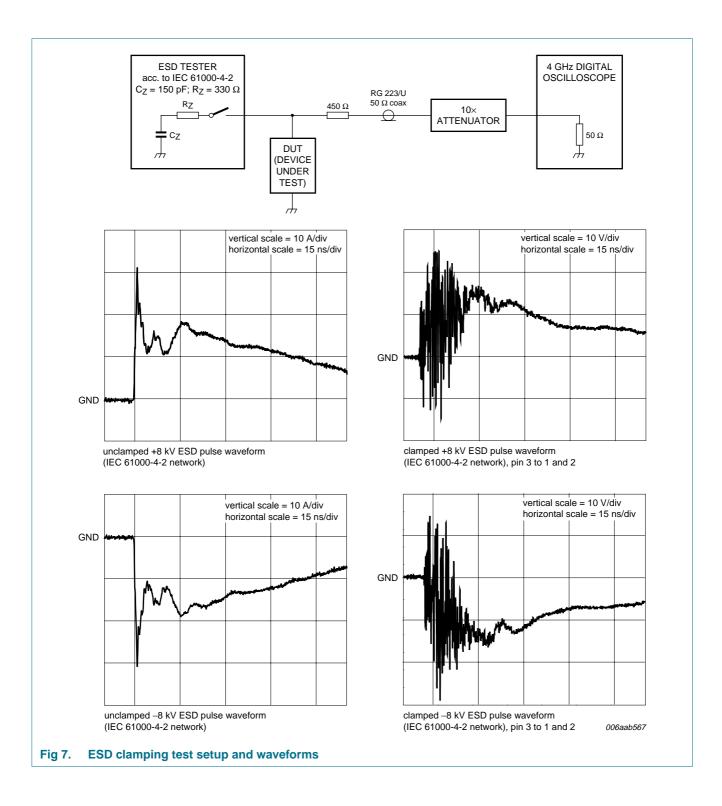


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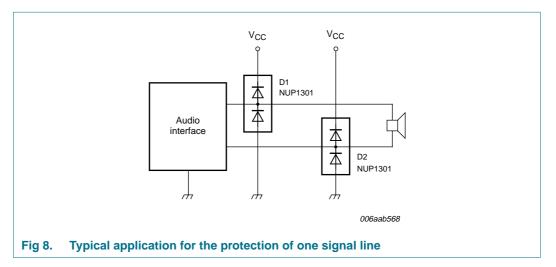


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### 8. Application information

Protection of a single (high-speed) data line in rail-to-rail configuration. The protected data line is connected to pin 3. Pin 1 is connected to ground (GND) and pin 2 is connected to the supply rail (supply voltage  $V_{CC}$ .) When the transient voltage exceeds the forward voltage drop of one diode, the transient is directed either to the supply rail or to GND. The advantages of these solutions are: low line capacitance (0.6 pF typically), fast response time, and low clamping voltage.



#### Circuit board layout and protection device placement:

Circuit board layout is critical for the suppression of ESD, Electrical Fast Transient (EFT) and surge transients. The following guidelines are recommended:

- 1. Place the NUP1301 as close to the input terminal or connector as possible.
- 2. The path length between the NUP1301 and the protected line should be minimized.
- 3. Keep parallel signal paths to a minimum.
- 4. Avoid running protected conductors in parallel with unprotected conductors.
- 5. Minimize all Printed-Circuit Board (PCB) conductive loops including power and ground loops.
- 6. Minimize the length of the transient return path to ground.
- 7. Avoid using shared transient return paths to a common ground point.
- 8. Ground planes should be used whenever possible. For multilayer PCBs, use ground vias.

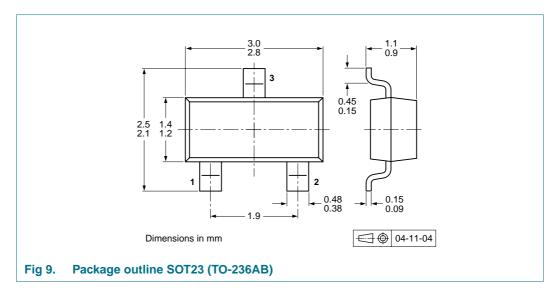
### 9. Test information

#### 9.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

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### 10. Package outline



# 11. Packing information

#### Table 10. Packing methods

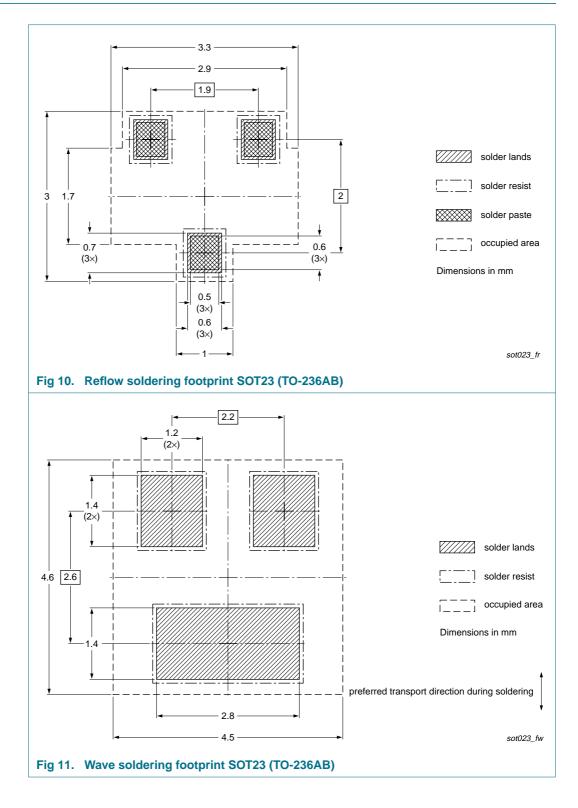
The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing	quantity
			3000	10000
NUP1301	SOT23	4 mm pitch, 8 mm tape and reel	-215	-235

[1] For further information and the availability of packing methods, see <u>Section 15</u>.

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### 12. Soldering



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# 13. Revision history

Table 11. Revision history							
Document ID	Release date	Data sheet status	Change notice	Supersedes			
NUP1301_1	20090511	Product data sheet	-	-			

#### Ultra low capacitance ESD protection array

### 14. Legal information

#### 14.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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